V1.0



## N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V} \,$

#### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

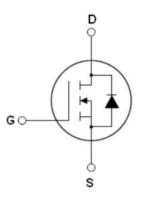
#### **Features**

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

#### **Application**

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V <sub>DS min@Tjmax</sub>	650	V
R <sub>DS(ON)TYP</sub> .	580	mΩ
$I_D$	6.7	Α
Qg	11	nC



Schematic diagram

## **Package Marking And Ordering Information**

Device	Device Package	Marking	
NCE60N640K	TO-252	NCE60N640K	



G D S

TO-252

#### Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (Vgs=0V)	VDS	600	V
Gate-Source Voltage (VDS=0V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	6.7	Α
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	4.69	А
Pulsed drain current (Note 1)	I <sub>DM (pluse)</sub>	20.1	Α
Maximum Power Dissipation(Tc=25℃)	P <sub>D</sub>	75	W
Derate above 25°C		0.5	W/°C
Avalanche current <sup>(Note 1)</sup>	I <sub>AS</sub>	1.5	Α
Reverse diode dv/dt, V <sub>DS</sub> ≤480 V,I <sub>SD</sub> <i<sub>D</i<sub>	dv/dt	15	V/ns
Drain Source voltage slope,V <sub>DS</sub> ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55+175	°C



#### **Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	2	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	62	°C /W

 Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250uA	600			V
Zero Gate Voltage Drain Current(Tc=25°ℂ)	I <sub>DSS</sub>	V <sub>DS</sub> =600V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =600V,V <sub>GS</sub> =0V			50	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±200	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250uA$	3	3.5	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.3A		580	640	mΩ
Dynamic Characteristics				•		
Gate Resistance	Rg	F=1MHZ, D-S short		39		Ω
Input Capacitance	C <sub>lss</sub>	\/ F0\/\/ 0\/		485		pF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$		12		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1MHz		3.72		pF
Total Gate Charge	Qg	V <sub>DS</sub> =400V,I <sub>D</sub> =3.3A, V <sub>GS</sub> =10V		11.0		nC
Gate-Source Charge	Q <sub>gs</sub>			3.3		nC
Gate-Drain Charge	$Q_{gd}$			2.4		nC
Gate plateau voltage	Vgp			4.9		V
Switching times				•		
Turn-on Delay Time	t <sub>d(on)</sub>			13		nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =380 $V$ , $I_{D}$ =3.3 $A$ ,		7		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G=4\Omega, V_{GS}=10V$		30		nS
Turn-Off Fall Time	t <sub>f</sub>			12		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	Isp	T -25°C			6.7	Α
Pulsed-Source-drain current(Body Diode)	Isom	T <sub>C</sub> =25°C			20.1	Α
Forward on voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =6.7A,V <sub>GS</sub> =0V		0.9	1.1	V
Reverse Recovery Time	t <sub>rr</sub>	T:_05°C   0.04		150		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I <sub>F</sub> =3.3A,		0.75		uC
Peak reverse recovery current	Irrm	di/dt=100A/µs		10		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25  $^{\circ}$ C,VDD=50V,VG=10V, R<sub>G</sub>=25 $\Omega$ 



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

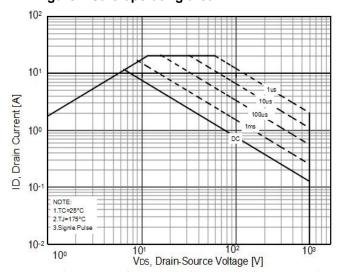


Figure 3. Transfer characteristics

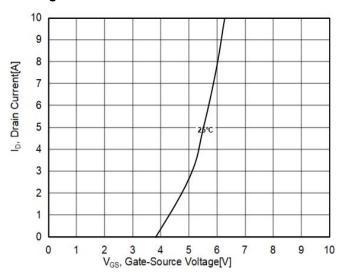


Figure 5. Static drain-source on resistance

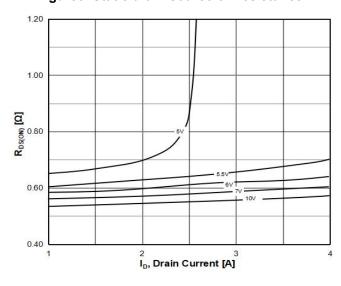


Figure 2. Source-Drain Diode Forward Voltage

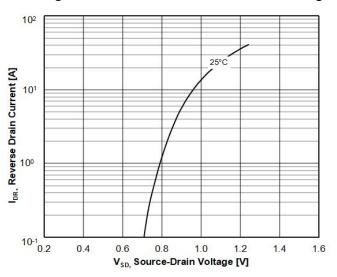


Figure4.Output characteristics

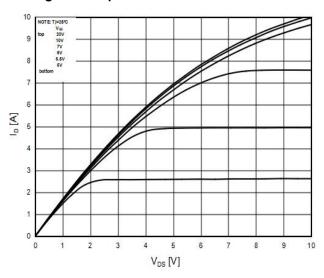
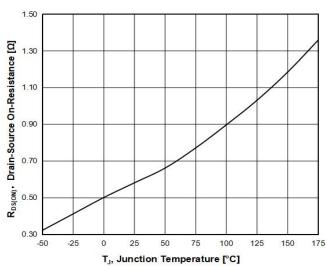


Figure 6. RDS(ON) vs Junction Temperature



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Figure 7. BV<sub>DSS</sub> vs Junction Temperature

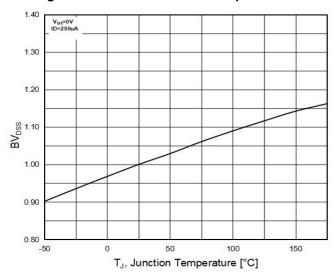


Figure8. Maximum I<sub>D</sub> vs Junction Temperature

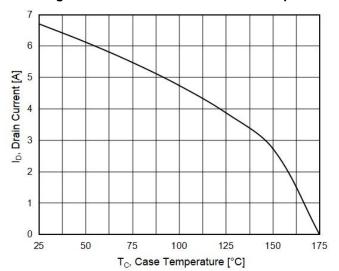


Figure 9. Gate charge waveforms

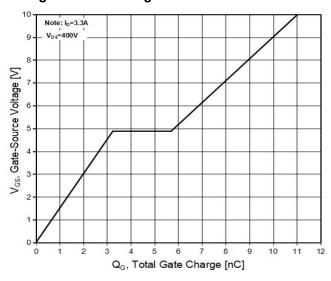
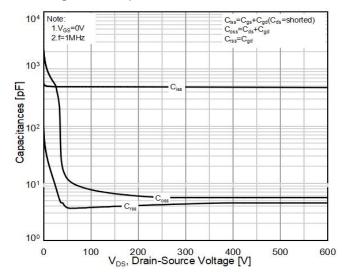


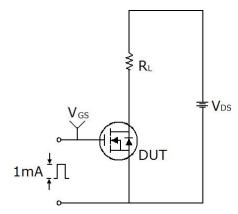
Figure 10. Capacitance

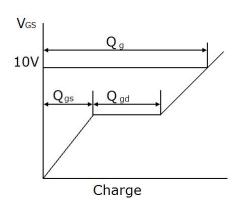




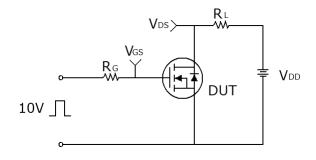
## **Test circuit**

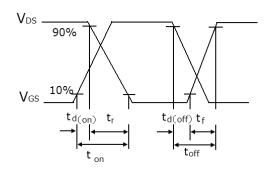
#### 1) Gate charge test circuit & Waveform



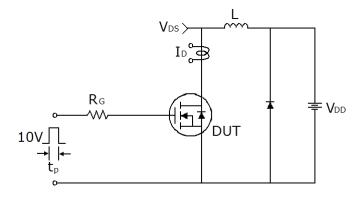


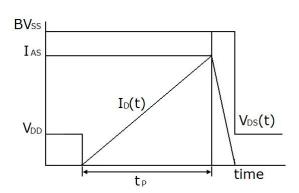
## 2) Switch Time Test Circuit:





#### 3) Unclamped Inductive Switching Test Circuit & Waveforms

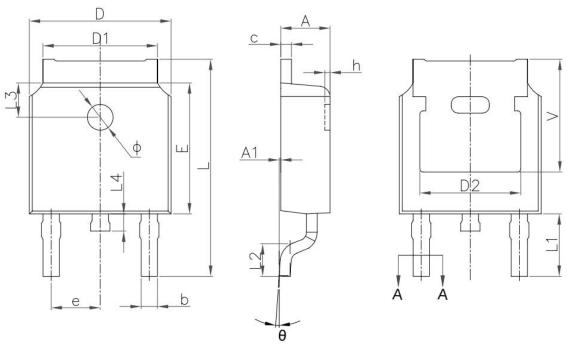




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# **TO-252-E Package Information**



Symbol	Dimensions	Dimensions In Millimeters Dimension		ns In Inches	
	Min.	Max.	Min.	Max.	
Α	2.20	2.40	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
b	0.66	0.86	0.026	0.033	
b1	0.73	0.79	0.029	0.031	
С	0.46	0.58	0.018	0.023	
c1	0.50	0.52	0.020	0.020	
D	6.50	6.70	0.256	0.264	
D1	5.10	5.46	0.201	0.215	
D2	4.83	3 REF	0.19REF		
Е	6.00	6.20 0.236		0.244	
е	2.19	2.39	0.086	0.094	
L	9.80	10.40	0.386	0.409	
L1	2.90	0 REF	0.11	REF	
L2	1.40	1.70	0.055		
L3	1.60	1.60 REF		REF	
L4	0.60	1.00	0.024	0.039	
Ф	1.10	1.30	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.00	0.30	0.000	0.012	



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